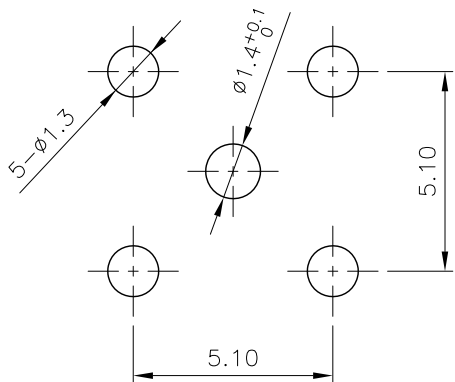
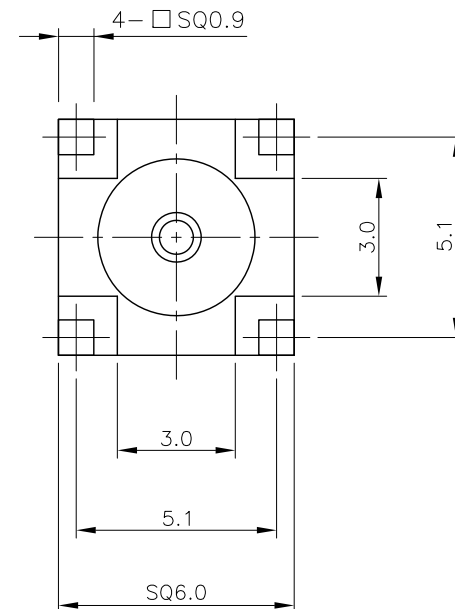
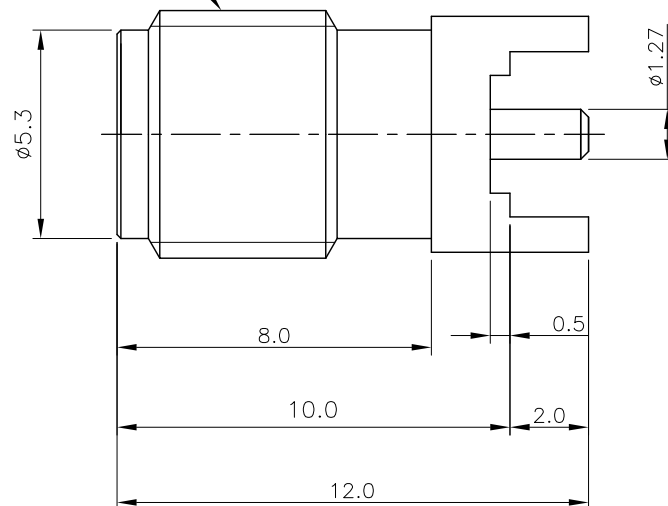




PCB MOUNTING HOLE

1/4-36 UNS-2A



*재질,도금,COC 성적서

주 기

1. 재질

- 1.1 몸체 : KS-D-5101 C3604BD-F 과삭황동봉
- 1.2 접촉핀 : ASTM-B196의 C17300, 베릴륨동
- 1.3 절연체 : SAE-AS1946또는 동등한 재료 (PTFE 테프론)

2. 보호피막처리 : 접촉핀은 MIL-DTL-45204, type II, class I

몸체는 MIL-DTL-45204, type II, class 00에 따라 처리 할 것

3. 전기적특성

- 3.1 특성 임피던스 : 50Ω
- 3.2 절연저항 : 1,000MΩ 이상
- 3.3 접촉저항 : 6.0mΩ 이하
- 3.4 D.W.V : AC 750Vrms 이상에서 1분간 견딜 것

4. 모든 덧살 및 날카로운 모서리를 제거할 것

5. 모든 치수는 참고 치수임

REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1 R	Initial Registration	S.H.KIM		2025.01.17.

3	INSULATOR	1	TEFLON		DIN01015-N/1
2	CONTACT	1	BeCu C17300	Gold Plate (1.27μm Min.)	DCT00204-5/2
1	BODY	1	MBsBD C3604BD-F	Gold Plate (0.508μm Min.)	DBD03903-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 01. 17.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY					
MATERIAL -		CHECKED BY			TITLE SMA50 PCB JS-4R		
		DRAWN BY S.H.KIM					
FINISH -		SCALE 5/1	UNIT mm		A4	PART NO. CN03310-7/4	
						REVISION	I R